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IEEE1394 ONE PORT CABLE TERMINATION NETWORK WITH ESD PROTECTION DIODES

MAIN APPLICATIONS

IPAD™

IEEE1394 line termination on:

- Desktops
- Notebooks
- Digital Camcorders
- External storage drive
- Set Top Box

FEATURES

- Line termination for 2 twisted pairs TPA and TPB
- The device complies with IEEE1394 requirement for differential and common more impedance on TPA and TPB line
- Monolithic device with complete termination for one IEEE1394 connection

DESCRIPTION

The ST1394-01SC6 is an integrated termination network that optimizes board layout of the PHY layer in IEEE1394 one port cable application.

This monolithic device is tested according to ESD requirement described in IEC01000-4-2 standard level 2. ST1394-01SC6 device ruggedness limits overvoltage at the 1094 tranceiver inputs and outputs below acceptable limits.

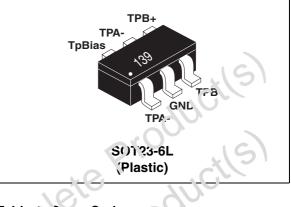
The Silis94-01SC6 implements IEEE1394 recommendation for line termination of TPA and TFB differential lines. Excellent matching of the termination resistor will minimize common mode noise that is needed to improve communication speed.

L'E NEFITS

- Resistor matching between TPA / TPB lines.
- Resistor matching between TPA+ / TPA-
- Single chip devise versus 11 discretes
- No need for additional overvoltage protection device
- High level of integration

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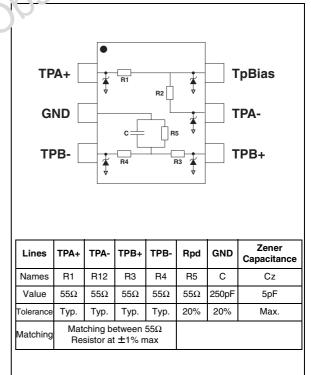
October 2004



ST1394

Table i. Order Code	00
Part Number	Marking
ST1394-01SC6	139
	•

Figure 1: Pinout Configuration



REV. 2

Symbol	Parameter and test conditions	Value	Unit	
T _{stg}	Storage temperature range	- 55 to + 150	°C	
Тj	Maximum junction temperature + 150 °			
TL	Lead solder temperature (10 second duration)	260	°C	

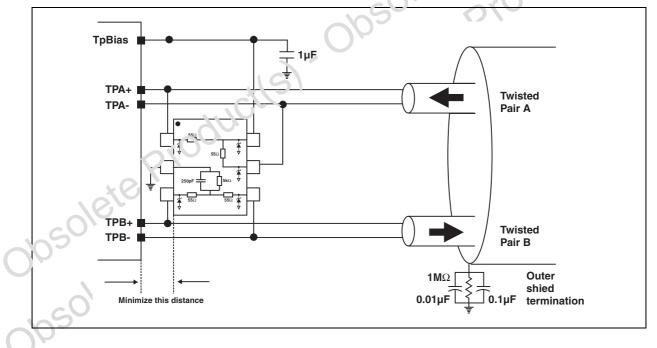
Table 2: Absolute Ratings ($T_{amb} = 25^{\circ}C$)

Table 3: Electrical Characteristics $(T_{amb} = 25^{\circ}C)$

Symbol	Parameter	Min.	Тур.	Max.	Unit
R1, R2, R3, R4	Bus termination resistors (note 1)		55		Ω
Cz	Zener capacitance			5	PΓ
R _{pd}	Pull down resistor		5		kΩ
С	Capacitor in parallel with R _{pd}		250	20	pF
(R1+R2), (R3+R4)	Bus termination impedance	102	110	0,18	Ω

Note 1: matching between 55 Ω resistors is better than ± 1%.

Figure 2: Functionnal Diagram



APPLICATION INFORMATION

The functional diagram here above presents a IEEE1394-a cable and shows how to connect the ST1394-01SC6 in order to correctly terminate and filter the TPA and TPB lines.

TECHNICAL INFORMATION: Frequency behavior of data and strobe signals

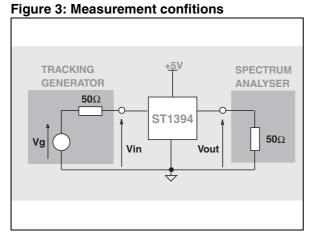


Figure 5: TPA line: comparison between Aplac model and device

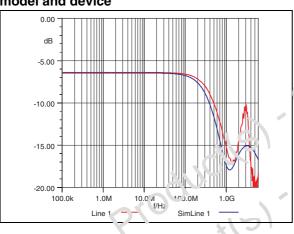


Figure 4: Test Board

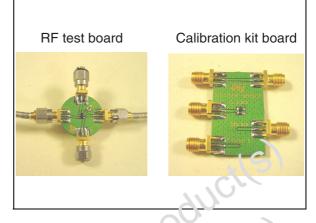
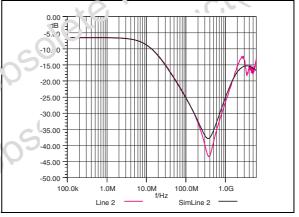


Figure 6: TPB line: ວາກາອ/ison between Aplac model and device



Note: For a curvenience reason, frequency response have been carried out on both TPA and TPB lines as if TPA+ and TPA- or TPB+ and TPB- were respectively Inputs and Outputs lines

Figure 7: Crosstalk between TPA and TPB lines

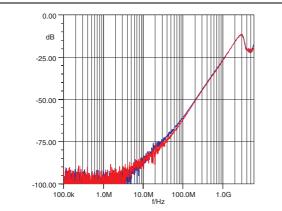


Figure 8: CST1394 APLAC model

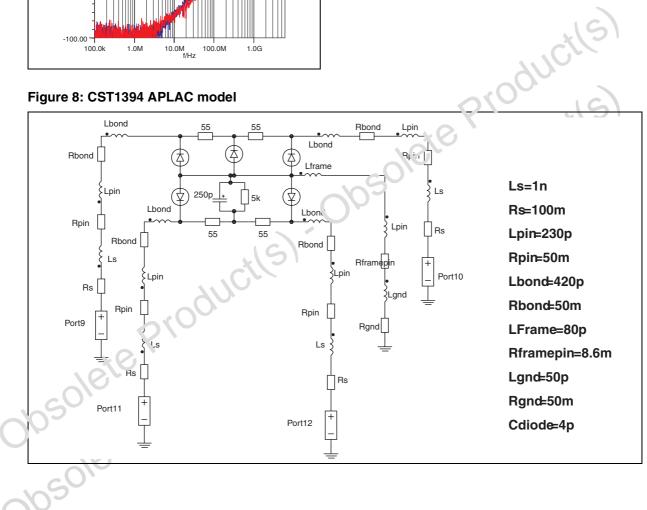
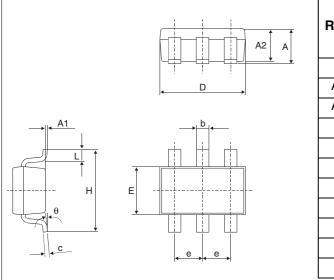


Figure 9: SOT23-6L Package Mechanical Data



	DIMENSIONS					
REF.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	0.90		1.45	0.035		0.057
A1	0		0.10	0		0.004
A2	0.90		1.30	0.035		0.051
b	0.35		0.50	0.014		0.02
С	0.09		0.20	0.004		0.008
D	2.80		3.05	0.110		0.120
Е	1.50		1.75	0.059	.10	ባ.୯69
е		0.95			0.057	[
Н	2.60		3.00	6 1 92		0.118
L	0.10		0.60	2004		0.024
θ		K	1.7°			10°

Figure 10: SOT23-6L Foot print dimensions (in millimeters)

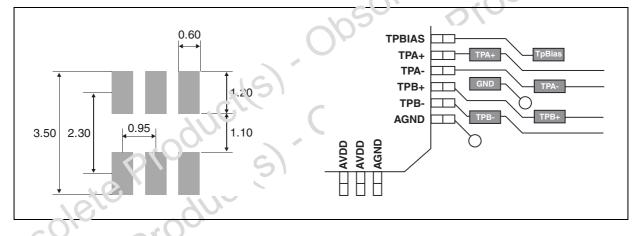


Table 4: Ordering Information

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
ST1394-01SC6	139	SOT23-6L	16.7 mg	3000	Tape & reel

Note: More informations are available in the application note: AN1783: "HOW TO MAKE FIRE-WIRE COMMUNICATION PORT SAFE?"

Table 5: Revision History

Date	Revision	Description of Changes
Jul-2003	1A	First issue.
28-Oct-2004	2	SOT23-6L package dimensions change for reference "D" from 3.0 millimeters (0.118 inches) to 3.05 millimeters (0.120 inches).

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